

**AK2364****Two-way Radio Filterless FM Detector LSI****1. Features**

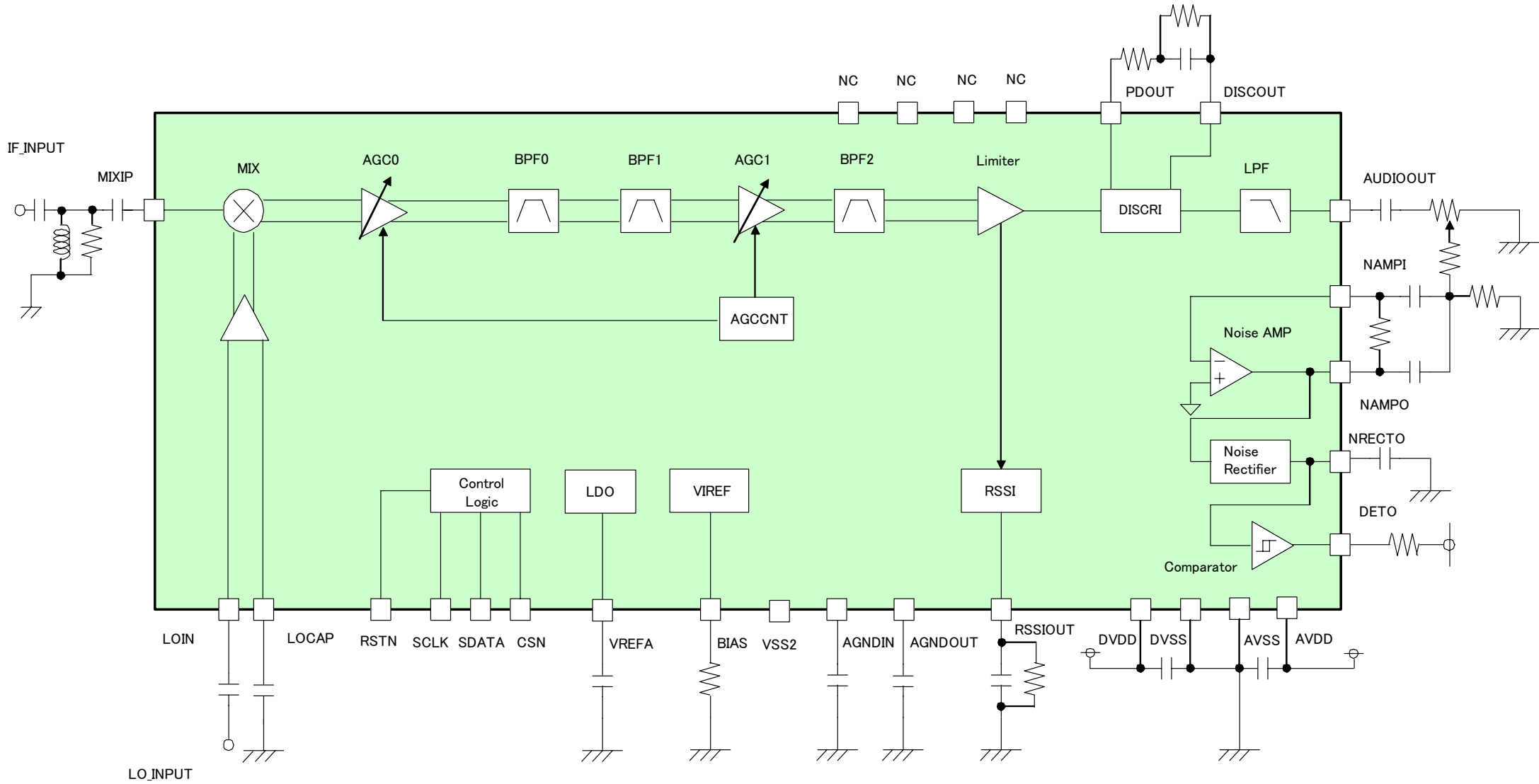
The AK2364 includes 2nd-Mixer, AGC+BPF, PLL FM detector, noise squelch, and RSSI circuit. This device can eliminate D to G type ceramic filters, quadrature discriminator, and other external components.

- Low operating voltage: VDD = 2.6 to 5.5 V
- Wide operating temperature: Ta = -40 to 85 °C
- Hi sensitivity: -104dBm at 12dB SINAD
- Built-in 2nd Mixer
- Local frequency: 45.9MHz, 50.4MHz, 57.6MHz (Triple of 15.3, 16.8 and 19.2MHz)
- Built-in programmable AGC+BPF circuits corresponding to D to G type ceramic filters
- Built-in PLL FM detector
- RSSI function
- Built-in noise squelch circuits
- Low consumption current: 7mA
- Compact plastic packaging, 28-pin QFNJ (4.0 x 4.0 x 0.75mm, 0.4mm pitch)

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3. Block Diagram



4. Circuit Configuration

Block	Description
MIX	2nd-mixer to convert the input signal down to 450Hz.
AGC+BPF	The circuit composed of AGC and BPF, where the desired signal is amplified and spurious components included in the signal from the 2nd-mixer are eliminated.
Divider	The circuit to divide the signal from LOIN pin and supply BPF with CLK.
LIMITER	The circuit to amplify the signal filtered at the AGC+BPF stage and generate rectangular wave.
DISCRI	The demodulator circuit with PLL FM detector, where the audio signal is recovered.
LPF	The Low-pass filter to eliminate the noise generated at the DISCRI stage.
Noise AMP	The amplifier to compose the Band-pass filter for noise squelch.
Noise Rectifier	The rectification circuit to detect the noise level.
Comparator	The circuit to compare the noise level with reference voltage level.
RSSI	The circuit to indicate the Received Signal Strength Indicator(RSSI) by generate a DC voltage corresponding to the input level from LIMITER.
VIREF	The circuit to generate internal reference voltage.
LDO	The circuit to supply 2.7V power for some circuits.
Control Logic	The control register controls the status of internal condition by serial data that consists of 1 instruction bit, 6 address bits and 8 data bits.

Note: When you use AK2364 in AVDD=2.6 to 3.6V operation, VREFA pin is connected to AVDD pin for power supplying.

5. Pin/Function

Package	Signal			Function	
	Pin No	Name	Type		Conditions at power down
	1	MIXIP	AI	Z	IF positive signal input pin
	2	AVSS	PWR	-	Analog ground pin
	3	VREFA	AI	H	Output pin to connect capacitor for LDO
	4	AVDD	PWR	-	Analog VDD power supply pin
	5	NC	AIO	Z	NC pin
	6	NC	AIO	Z	NC pin
	7	NC	AIO	Z	NC pin
	8	NC	AIO	Z	NC pin
	9	RSSIOUT	AO	Z	Output pin to connect capacitor for Received Signal Strength Indicator(RSSI)
	10	PDOUT	AO	Z	Pin1 for DISCRIMINATOR Low-pass filter
	11	DISCOUT	AO	Z	PIN2 for DISCRIMINATOR Low-pass filter
	12	AUDIOOUT	AO	Z	Demodulated audio signal output pin
	13	NAMPI	AI	Z	Input pin for noise squelch amplifier
	14	NAMPO	AO	Z	Output pin for noise squelch amplifier
	15	NRECTO	AI	Z	Output pin for the rectification circuit
	16	BIAS	AO	Z	Output pin to connect bias resistor for reference voltage
	17	AGNDOUT	AO	Z	Analog ground output pin. Connect the capacitor to stabilize the analog ground level.
	18	AGNDIN	AI	Z	Analog ground input pin. Connect the capacitor to stabilize the analog ground level.
	19	VSS2	PWR	-	VSS power supply pin. Normally supply 0V to this pin.
	20	RSTN	DI	Z	Hardware reset pin
	21	CSN	DI	Z	Chip select input pin for serial data
	22	SCLK	DI	Z	Clock input pin for serial data
	23	SDATA	DB	-	Input and output pin for serial data
	24	DETO	DO	Z	Signal detect output pin
	25	DVDD	PWR	-	Digital VDD power supply pin.
	26	DVSS	PWR	-	Digital ground pin
	27	LOCAP	AI	Z	Local signal input pin
	28	LOIN	AI	Z	Local signal input pin

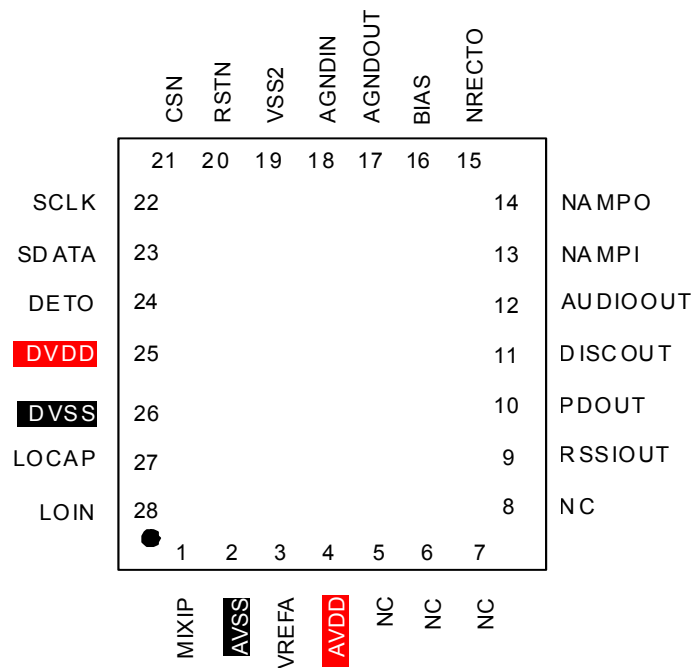
Note:

A: Analog, **D:** Digital, **PWR:** Power, **I:** Input, **O:** Output, **B:** Bidirectional, **Z:** High-Z, **L:** Low

When you use AK2364 in AVDD=2.6 to 3.6V operation, VREFA pin is connected to AVDD pin for power supplying. Please set LDO (Low Drop Out) power off setting.

When VREFA pin is supplied by external power supply, absolute maximum ratings and recommended operating conditions are based on AVDD level.

• Pin Assignment



6. Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units
Power Supply Voltage	AVDD	-0.3	6.5	V
	DVDD	-0.3	6.5	V
Ground Level	VSS	0	0	V
Input Voltage	V _{IN} analog	-0.3	AVDD+0.3	V
	V _{IN} digital	-0.3	DVDD+0.3	V
Input Current (Except power supply pin)	I _{IN}	-10	+10	mA
Storage Temperature	T _{stg}	-55	130	°C

Note : All voltages are relative to the VSS pin.

Caution : Exceeding these maximum ratings can result in damage to the device.
Normal operation cannot be guaranteed under this extreme.

7. Recommended Operating Conditions

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Operating Temperature	T _a		-40		85	°C
Power Supply Voltage	AVDD		2.6	3.0	5.5	V
	DVDD	DVDD ≤ AVDD	2.6	3.0	5.5	V
Analog Reference Voltage	AGND	LDO in use		1.35		V
		LDO not in use		1/2DVDD		V
Output Load Resistance	R _L	AUDIOOUT, DISCOUNT, NAMPO	30			kΩ
Output Load Capacitance	C _L	AUDIOOUT, DISCOUNT, NAMPO			15	pF

Note : All voltages are relative to the VSS pin.

8. Digital DC Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
High level input voltage	V _{IH}	RSTN, SCLK, SDATA CSN	0.8DVDD			V
Low level input voltage	V _{IL}	RSTN, SCLK, SDATA CSN			0.2DVDD	V
High level input current	I _{IH}	V _{IH} =DVDD RSTN, SCLK, SDATA CSN			10	μA
Low level input current	I _{IL}	V _{IL} =0V RSTN, SCLK, SDATA CSN	-10			μA
High level output voltage	V _{OH}	I _{OH} =+0.2mA SDATA	DVDD-0.4		DVDD	V
Low level output voltage	V _{OL}	I _{OL} =-0.4mA SDATA, DETO	0.0		0.4	V

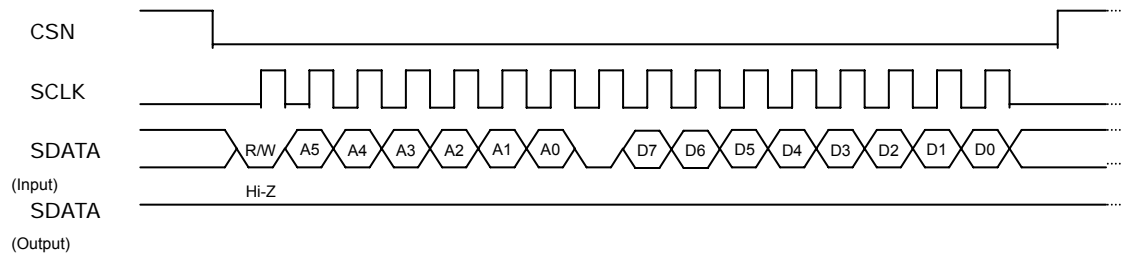
9. Digital AC Timing

1) Serial Interface Timing

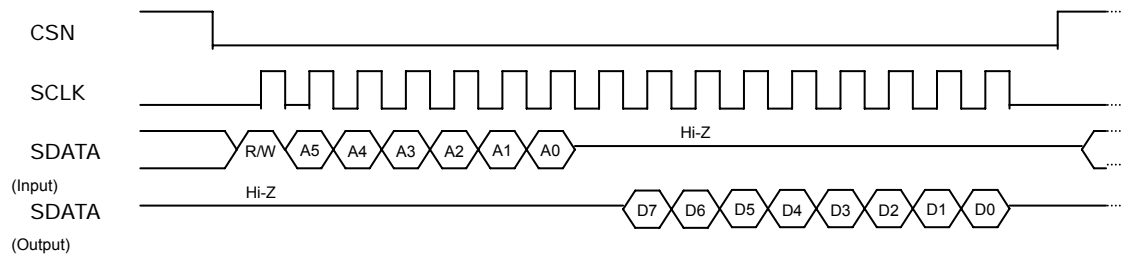
AK2364 is connected to a CPU by three-wired interface through CSN, SCLK and SDATA pins, which can make reading and writing data for control registers.

Serial data named SDATA is consist of 1-bit read and write instruction(R/W), 6-bit address (A5 to A0) and 8-bit data (D7 to D0) in one frame.

Write mode



Read mode



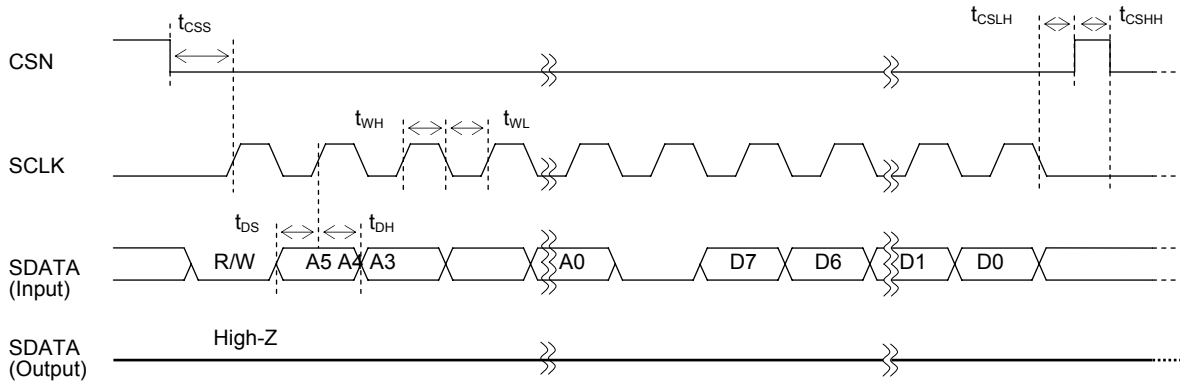
R/W : Instruction bit controls to write data to AK2364 or read back from it.
When set to low, AK2364 is in write mode. When set to high, AK2364 is in read mode.

A5 to A0: Register address to be accessed.
D7 to D0: Write or read data to be accessed.

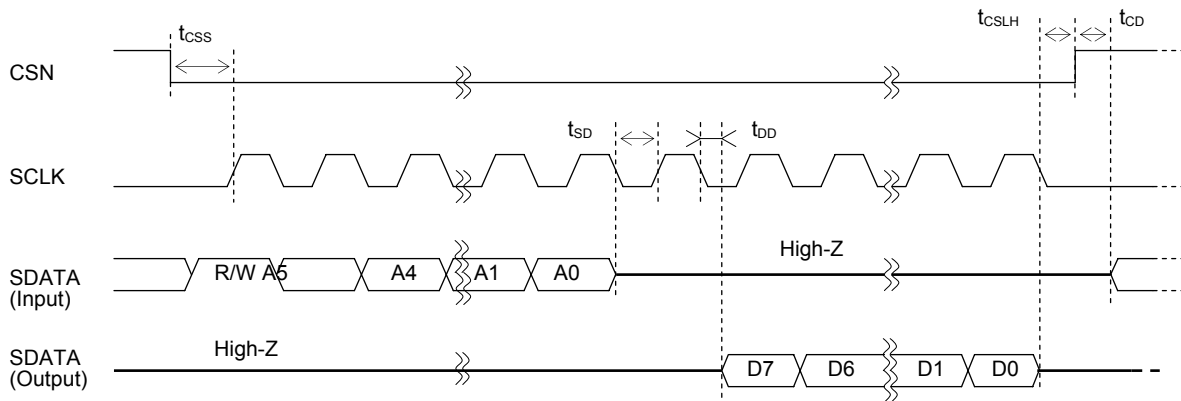
- <1> CSN(Chip select) is normally selected high for disable.
When CSN is set to low, serial interface becomes active.
- <2> In write mode, instruction, address and data input from SDATA pin are synchronized and latched with the rising edge of 16 iterations of SCLK clock. Set to low between address A0 and data D7. Input data is fixed synchronized with the rising edge of 16th clock. Note that if CSN become "H" before 16th clock, setting data becomes invalid. During the period when CSN is set to "L", consecutive writing is available.
- <3> In read mode, instruction and address are synchronized and latched with the rising edge of 7 iterations of SCLK clock. And the register data are output from SDATA pin synchronized with the falling edge of 9 iterations of SCLK clock. The data between address A0 and data D7 is unstable. During the period when data is output, input to SDATA must be "Hi-z". Set CSN to "H" once reading is completed because consecutive reading is not valid.

2) Detail Timing Chart

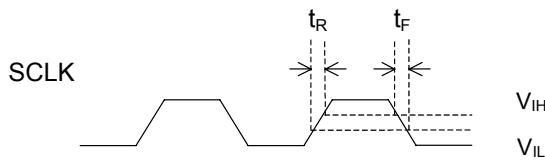
Write mode



Read mode



Rising and falling time



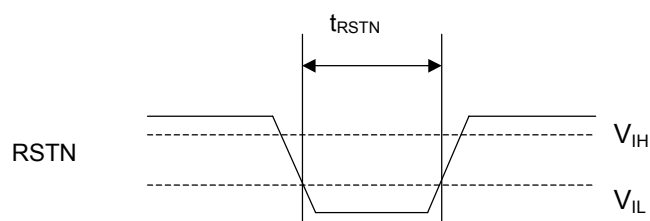
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
CSN setup time	t_{CSS}		100			ns
SDATA setup time	t_{DS}		100			ns
SDATA hold time	t_{DH}		100			ns
SCLK high time	t_{WH}		500			ns
SCLK low time	t_{WL}		500			ns
CSN low hold time	t_{CSLH}		100			ns
CSN high hold time	t_{CSHH}		100			ns
SDATA Hi-Z setup time	t_{SD}		500			ns
SCLK to SDATA output delay time	t_{DD}	20pF load			400	ns
CSN to SDATA input delay time	t_{CD}	20pF load	200			ns
SCLK rising time	t_R				250	ns
SCLK falling time	t_F				250	ns

Note: Digital input and output timing is relative to 0.5DVDD of rising signal and falling signal.

10. System Reset

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remarks
Hardware reset signal input width	t_{RSTN}	RSTN pin	1			us	*1)
Software reset		SRST register					*2)

- *1) After power-on, be sure to perform a hardware reset operation (register initialization). The system is reset by a low pulse input of 1 μ s (min.) and enters the normal operation state. At this moment, the digital (DI) pins are set as follows: RSTN pin to high, SCLK pin to Low, SDATA pin to low, CSN pin to low.



- *2) When data 0x03:10101010 is written to the SRST[7:0] register, software reset is performed. This setting initializes the registers and the operation mode is set to mode 0 (power down). After software reset is completed, this register comes to "0".

11. Power Consumption

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Consumption Current	IDD0	Mode 0 Power down			10	μ A
	IDD1	Mode 1 Standby, AGN DIN		0.1	0.2	mA
	IDD2	Mode 2 Standby, Lo buffer, VIREF		0.6	1.4	mA
	IDD3	Mode 3 When no input signal		7.0	10	mA

12. Analog Characteristics

For the following conditions unless otherwise specified: LOIN=50.4MHz, MIXIP=50.85MHz, $\Delta f = \pm 1.5\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, AGC+BPF=F4, the exposure back pad of the package is connected to VSS, with the external circuit shown in example page 21 to 24.

1) Local

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units	Notes
Local Frequency	F_{LO}	LOIN		45.9 50.4 57.6		MHz	
Input amplitude	V_{LO}	LOIN	0.2		1.0	V_{PP}	Note)

Note) Input from LOIN pin through DC cut

2) 2nd Mixer

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Input Impedance	Note)		50		Ω	Note)
Input Frequency			F_{LO} +0.45		MHz	
Voltage Gain			23		dB	
Noise Figure			13		dB	

Note) Include external matching circuit

3) Discriminator

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Demodulation Output Level	$\Delta f = \pm 3.0\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, LIMITER IN to AUDIOOUT Note)	60	100	140	mVrms	BAND =1
	$\Delta f = \pm 1.5\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, LIMITER IN to AUDIOOUT Note)	60	100	140	mVrms	BAND =0
S/N Ratio	$\Delta f = \pm 3.0\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, LIMITER IN to AUDIOOUT Note)		50		dB	BAND =1

Note) With De-emphasis + BPF(0.3 to 3kHz)

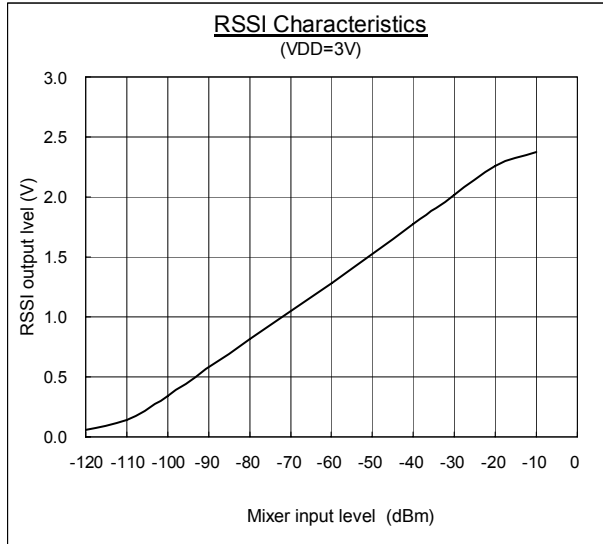
4) RX Overall Characteristics

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
12dB SINAD Input Sensitivity	Note)		-104		dBm	
IIP3			-16		dBm	
Demodulation Output Level	$\Delta f = \pm 3.0\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, AGC+BPF=F3 Note)	60	100	140	mVrms	BAND =1
	$\Delta f = \pm 1.5\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, AGC+BPF=F4 Note)	60	100	140	mVrms	BAND =0
S/N Ratio	$\Delta f = \pm 3.0\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, AGC+BPF=F3 Note)	40	46		dB	BAND =1
	$\Delta f = \pm 1.5\text{kHz}$, $f_{\text{mod}} = 1\text{kHz}$, AGC+BPF=F4 Note)	34	40		dB	BAND =0

Note) With De-emphasis + BPF(0.3 to 3kHz)

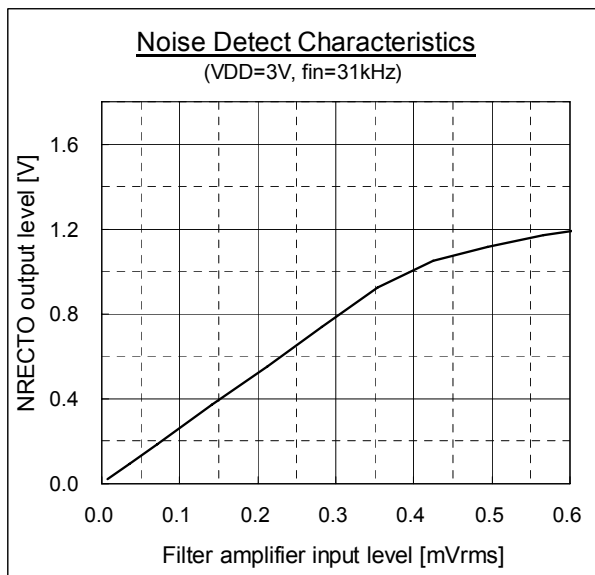
5) RSSI Characteristics

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
RSSI Output Voltage	MIXIP --> RSSIOUT MIXIP=-100dBm Input	0.1	0.36	0.62	V	
	MIXIP --> RSSIOUT MIXIP=-30dBm Input	1.4	2.0	2.6	V	



6) Noise Squelch Characteristics

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Noise Detect Level	NRECTO --> DETO Detect High		0.5	0.7	V	
	NRECTO --> DETO Detect Low	0.3	0.4		V	
Noise Detect Characteristic	NAMPI --> NRECTO Input: 31kHz, 0.1mVrms	0.1	0.26	0.36	V	
	NAMPI --> NRECTO Input: 31kHz, 0.25mVrms	0.4	0.65	0.8	V	



7.1) F1 (D type)

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Attenuation Characteristics (relative to the gain at 450kHz)	430kHz			-50	dB	
	440kHz	-6			dB	
	460kHz	-6			dB	
	470kHz			-50	dB	
Gain Ripple	Within 450±7kHz			3	dB	

7.2) F2 (E type)

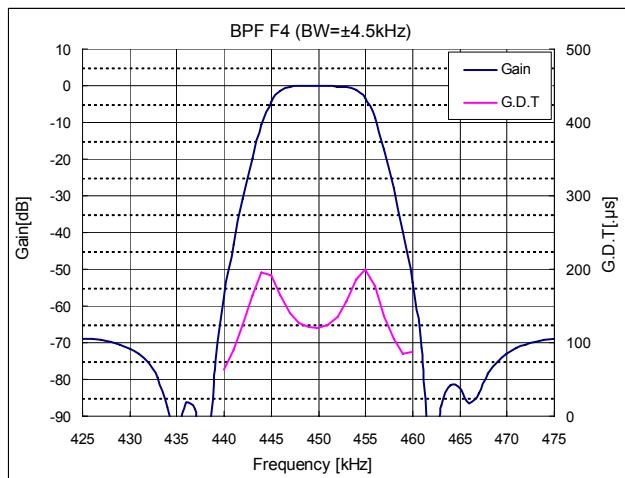
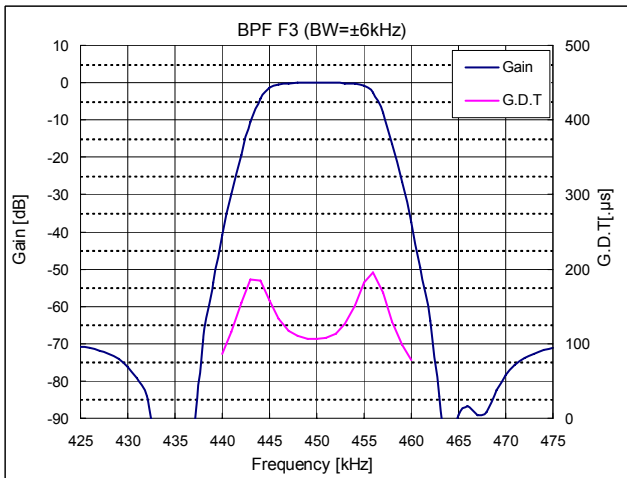
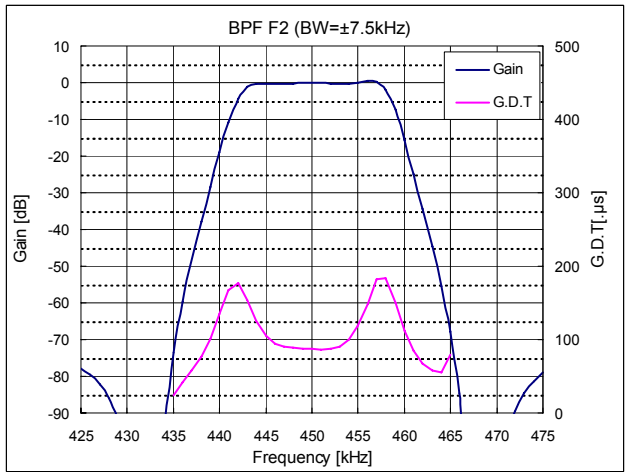
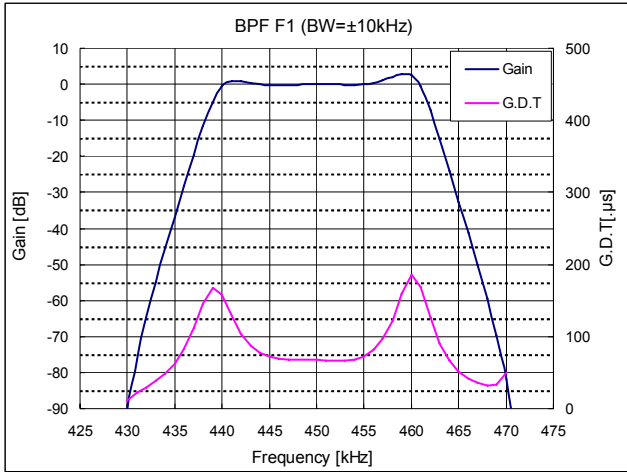
Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Attenuation Characteristics (relative to the gain at 450kHz)	435kHz			-50	dB	
	442.5kHz	-6			dB	
	457.5kHz	-6			dB	
	465kHz			-50	dB	
Gain Ripple	Within 450±5kHz			3	dB	

7.3) F3 (F type)

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Attenuation Characteristics (relative to the gain at 450kHz)	437.5kHz			-50	dB	
	444kHz	-6			dB	
	456kHz	-6			dB	
	462.5kHz			-50	dB	
Gain Ripple	Within 450±4kHz			3	dB	

7.4) F4 (G type)

Parameter	Condition	Min.	Typ.	Max.	Units	Notes
Attenuation Characteristics (relative to the gain at 450kHz)	439kHz			-50	dB	
	445.5kHz	-6			dB	
	454.5kHz	-6			dB	
	461kHz			-50	dB	
Gain Ripple	Within 450±3kHz			3	dB	



13. Serial Interface Configuration

1) Register Configuration

Name	ADRS	D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)	W/R
Control register 1	0x01	LDOSTAT	PDLDON	BPF_BW[1:0]		LOFREQ[1:0]		BS[1:0]		W/R
		1	0	0	0	0	1	0	1	
Control register 2	0x02	Reserved			AGC_TIME[1:0]		AGC0_STEP	BAND	CAL	W/R
		0	0	0	0	0	1	0	0	
Software -reset	0x03	SRST[7:0]								W
		—	—	—	—	—	—	—	—	

Note: Do not access the data except specified address above.

2) Description of registers

Address 0x01 (Control Register 1)

Name	D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
Control Register 1	LDOSTAT	PDLDON	BPF_BW[1:0]		LOFREQ[1:0]		BS[1:0]	
Initial Value	1	0	0	0	0	1	0	1

LDO setting

Data	Function	Operation		Notes
		0	1	
LDOSTAT	Output status In LDO power down	AVSS shorted	AVDD shorted	
PDLDON	LDO power control	OFF	ON	

BPF band width setting

BPF_BW [1]	BPF_BW [0]	name	6dB attenuation
0	1	F1	±10kHz
0	0	F2	±7.5kHz
1	0	F3	±6kHz
1	1	F4	±4.5kHz

Local frequency setting

LOFREQ [1]	LOFREQ [0]	Local frequency
0	0	45.9MHz
0	1	50.4MHz
1	0	57.6MHz

Note: Do not set the combination of the code which is not defined in the table given above.

Operation mode setting

BS[1]	BS[0]	Mode name	AGNDIN	VIREF system	Circuits except AGNDIN, LOBUF,VIREF
0	0	Mode0(Power-down)	OFF	OFF	OFF
0	1	Mode1(standby)	ON	OFF	OFF
1	0	Mode2	ON	ON	OFF
1	1	Mode3	ON	ON	ON

Address 0x02 (Control Register 2)

Name	D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
Control Register 2	Reserved			AGC_TIME[1:0]		AGC0_STEP	BAND	CAL
Initial Value	0	0	0	0	0	1	0	0

AGC_TIME[1:0] : AGC response time setting

This register set response time for AGC0 gain and AGC1 gain to change by 1step.

AGC_TIME [1]	AGC_TIME [0]	AGC response time [ms]					
		AGC0_STEP=0 setting			AGC0_STEP=1 setting		
		State A	State B	State C	State A	State B	State C
0	0	0.56	8.50	8.50	0.38	4.35	4.35
0	1	0.92	8.79	8.79	0.56	4.50	4.50
1	0	1.64	9.37	9.37	0.93	4.79	4.79
1	1	3.08	10.52	10.52	1.66	5.38	5.38

Note: Values above indicate response time during AGC gain changes from maximum to minimum or from minimum to maximum.

Note: AGC response time differs according to the following states.

State A: AGC0 output level is beyond the upper limit.

State B: AGC0 output level is within the upper limit and AGC1 output level is beyond the upper limit.

State C: AGC1 output level is under the lower limit.

Data	Function	Operation		Notes
		0	1	
AGC0_STEP	AGC0 gain switching range setting	±1dB	±2dB	
BAND	Demodulated signal level setting (Note1)	NARROW	WIDE	
CAL	Discriminator circuit calibration start trigger (Note2)	Invalid	Start	

Note1: When {BAND} register is set to "0", demodulated signal level at AUDIOOUT pin, when input signal is $\Delta f = \pm 1.5\text{kHz}$ dev, is 100mVrms typ. When {BAND} register is set to "1", demodulated signal level at AUDIOOUT pin, when input signal is $\Delta f = \pm 3.0\text{kHz}$ dev, is 100mVrms typ.

Note2: calibration is performed synchronized with the rising edge of {CAL}. After calibration is completed, this register is set to "0" automatically. It takes 1.3ms before calibration is completed. Refer to "calibration procedure" for further information.

Address 0x03 (Software Reset)

Name	D7(MSB)	D6	D5	D4	D3	D2	D1	D0(LSB)
Software-reset	SRST[7:0]							
Initial Value	—	—	—	—	—	—	—	—

When data 0x03:10101010 is written to the SRST[7:0] register, software reset is performed. Refer to System Reset for further information.

14. Calibration Procedure

1) AVDD=2.6 to 3.6V operation

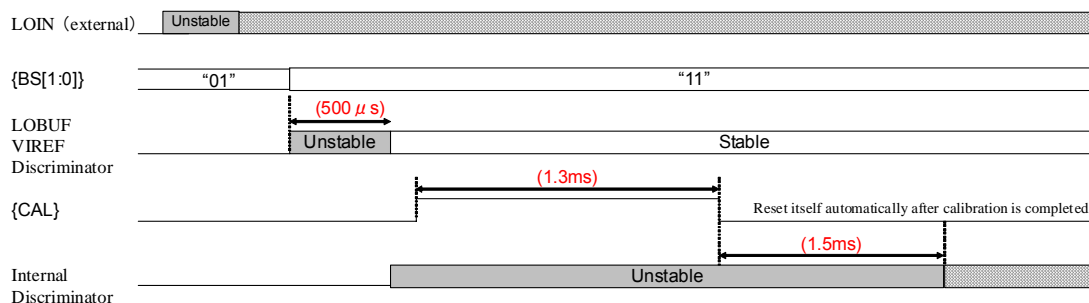
When you use AK2364 in AVDD=2.6 to 3.6V operation, VREFA pin is connected to AVDD pin for power supplying. Please set LDO (Low Drop Out) power off setting. Refer to 4-1) in page 22.

AK2364 employs a function to calibrate free-running frequency of VCO in Discriminator and demodulated signal level. Before starting RX Operation, calibration is required in order to acquire proper VCO operation range and demodulated signal level.

Following procedure is required before calibration in LDO power off setting.

- <1> Start up the external TCXO and continuously supply LO signal to AK2364.
- <2> Set "11" to 0x01 {BS[1:0]} and start up all circuits. After this operation, the circuits necessary for calibration (LOBUF, VIREF and Discriminator) will be powered on and calibration can be possible in 500us.
- <3> Calibration is begun by setting "1" to address 0x02 {CAL}. When the calibration is executed once, the calibration operation cannot be stopped excluding master reset. Even if "0" is written in {CAL}, the calibration is completely executed.
- <4> Calibration data is maintained excluding the time when the master reset is executed or DVDD power supply is down.
- <5> It takes 1.5ms for Discriminator to become steady after the calibration is completed.

Power-up sequence recommendation



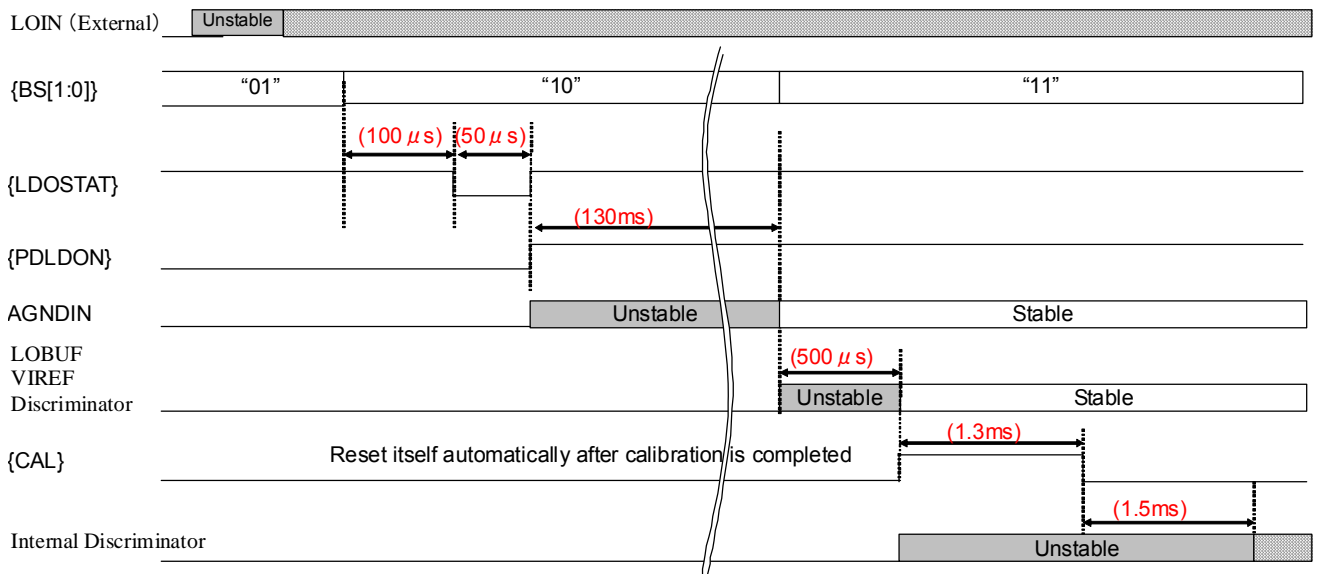
2) AVDD=3.6 to 5.5V operation

When you use AK2364 in AVDD=3.6 to 5.5V operation, please set LDO power on setting.
Refer to 4-2) in page 23.

Following procedure is required before calibration in LDO power on setting.

- <1> Start up the external TCXO and continuously supply LO signal to AK2364.
- <2> Set "10" to 0x01 {BS[1:0]} and start up VIREF circuits. This makes LDO set power up standby.
- <3> Set "0" to 0x01 {LDOSTAT} and LDO output shortened VSS once. This makes LDO power up time shortly.
- <4> Set "1" to 0x01 {LDOSTAT} and "1" to 0x01 {PDLDON}, then LDO power is on. It takes 130ms for AGNDIN pin output voltage to become stable.
- <5> Set "11" to 0x01 {BS[1:0]} and start up all circuits. After this operation, the circuits necessary for calibration (LOBUF, VIREF and Discriminator) will be powered on and calibration can be possible in 500us.
- <6> Calibration is begun by setting "1" to address 0x02 {CAL}. When the calibration is executed once, the calibration operation cannot be stopped excluding master reset. Even if "0" is written in {CAL}, the calibration is completely executed.
- <7> Calibration data is maintained excluding the time when the master reset is executed or DVDD power supply is down.
- <8> It takes 1.5ms for Discriminator to become stable after the calibration is completed.

Power-up sequence recommendation

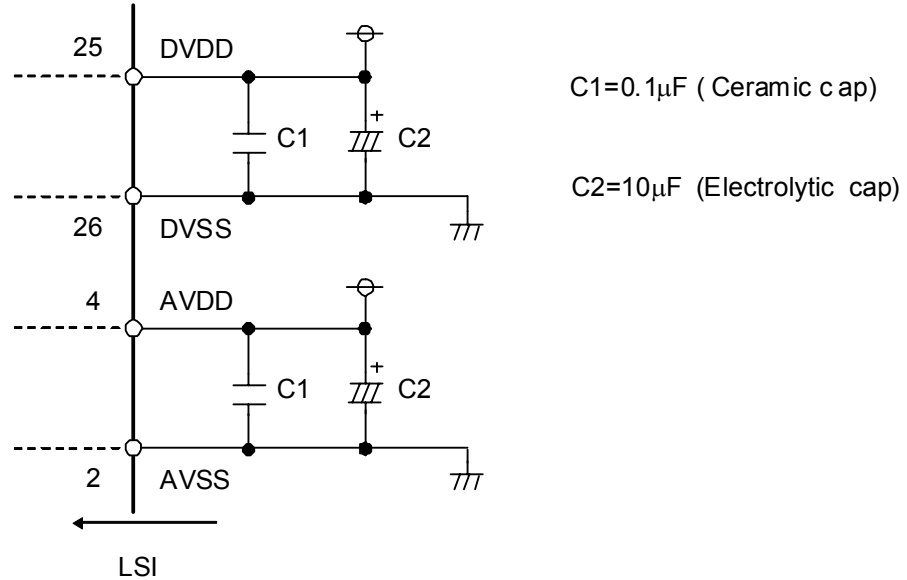


Note: These values refer to the following recommended external application circuits.

15. Recommended External Application Circuits

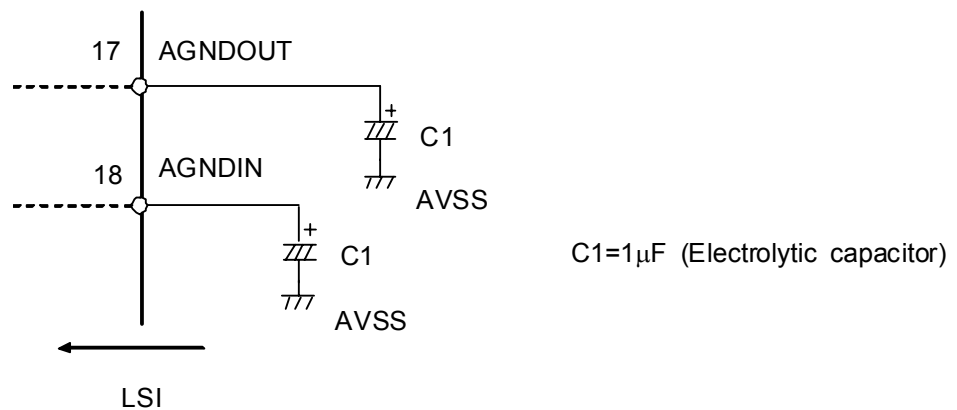
1) Power supply stabilizing capacitors

Connect capacitors between VDD and VSS pins to eliminate ripple and noise included in power supply. For maximum effect, the capacitors should be placed at a shortest distance between the pins.

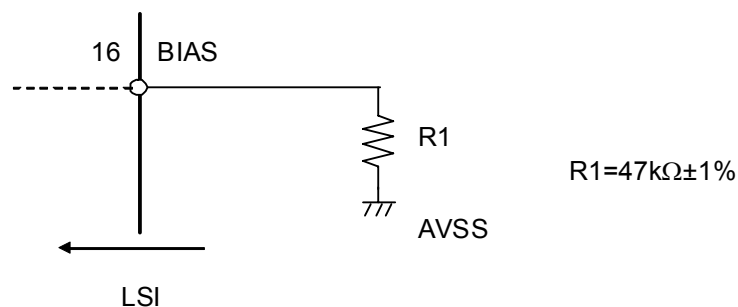


2) AGND stabilizing capacitors

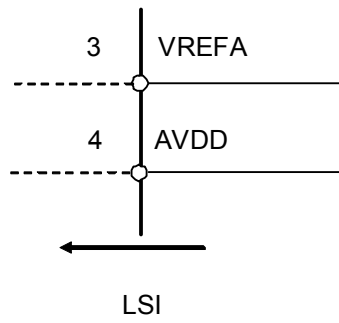
It is recommended that capacitors with 1 μ F or larger be connected between VSS and the AGND and AGNDIN pins to stabilize the AGND signal. The capacitors must be placed as close to the pins as possible.



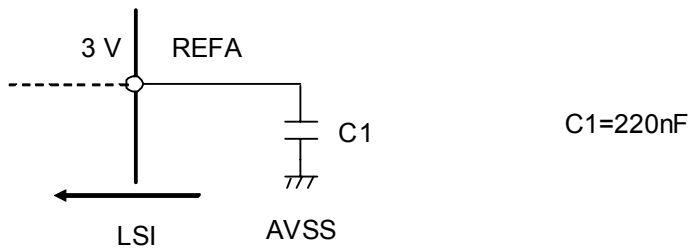
3) BIAS



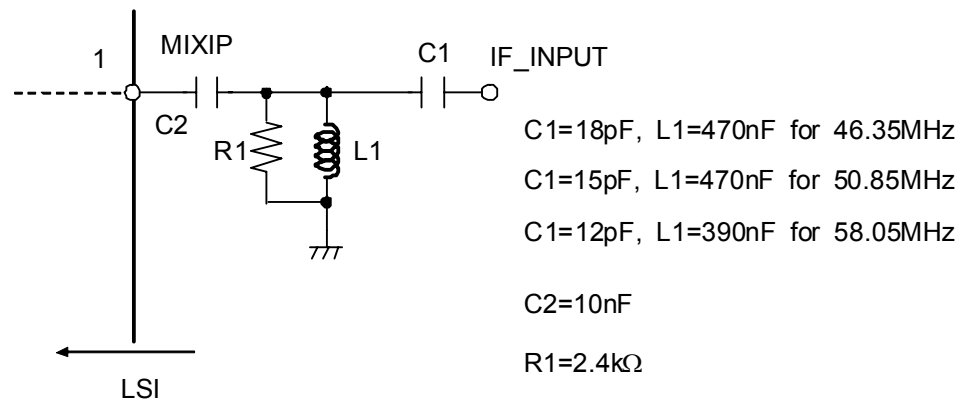
4-1) VREFA (AVDD=2.6 to 3.6V operation)



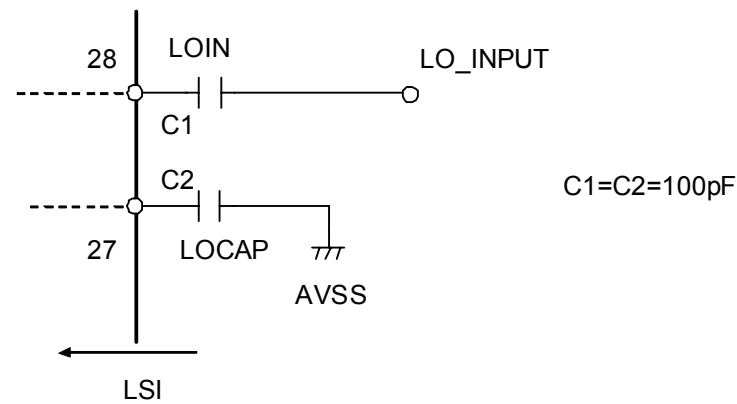
4-2) VREFA (AVDD=3.6 to 5.5V operation)



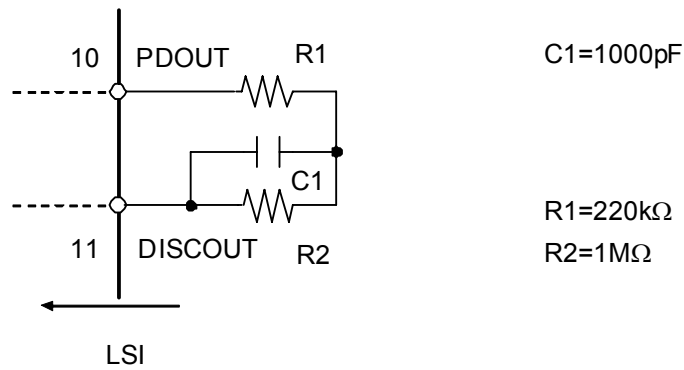
5) MIX



6) LOIN

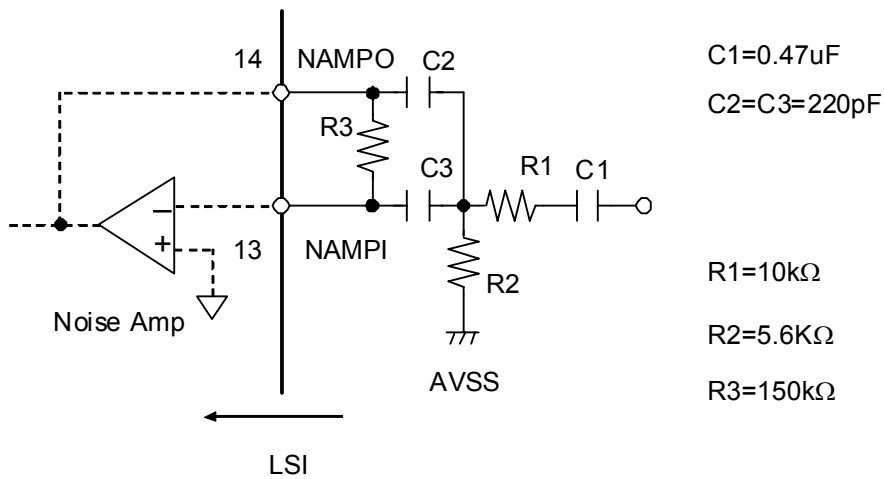


7) Discriminator



8) Noise AMP

The following gives a sample configuration of a BPF when input frequency is 31 kHz. Some parameters can be calculated using following (1) to (3) equations.



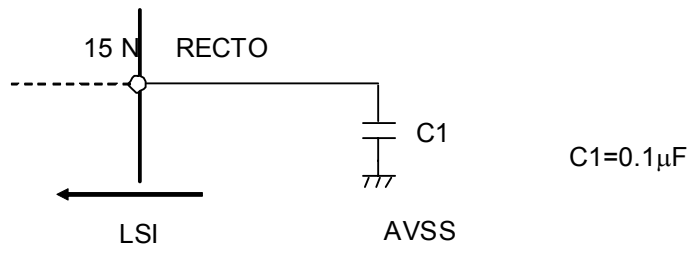
$$(1) f_0 = \frac{1}{2\pi\sqrt{R_3(R_1 // R_2)C^2}}$$

$$(2) G_v = \frac{R_3}{2R_1}$$

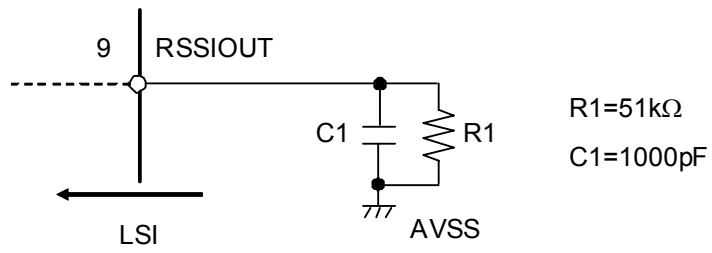
$$(3) Q^2 = \frac{R_3}{4(R_1 // R_2)}$$

9) NECTO

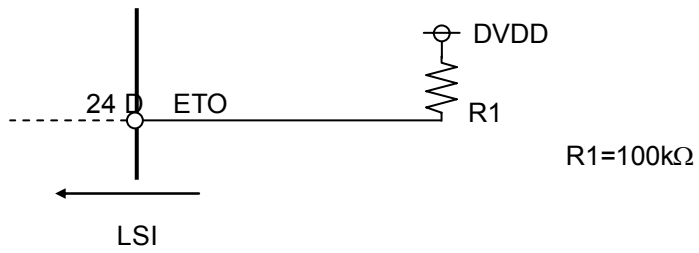
Rise time of noise detection is proportionate to $C1=0.1\mu\text{F}$ and internal resistance $75\text{k}\Omega$



10) RSSIOUT

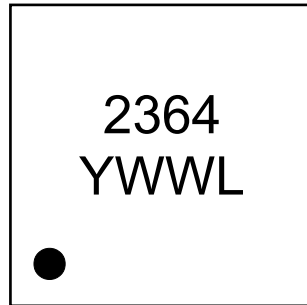


11) DETO



16. Packaging

Marking



[Contents of YWWL]

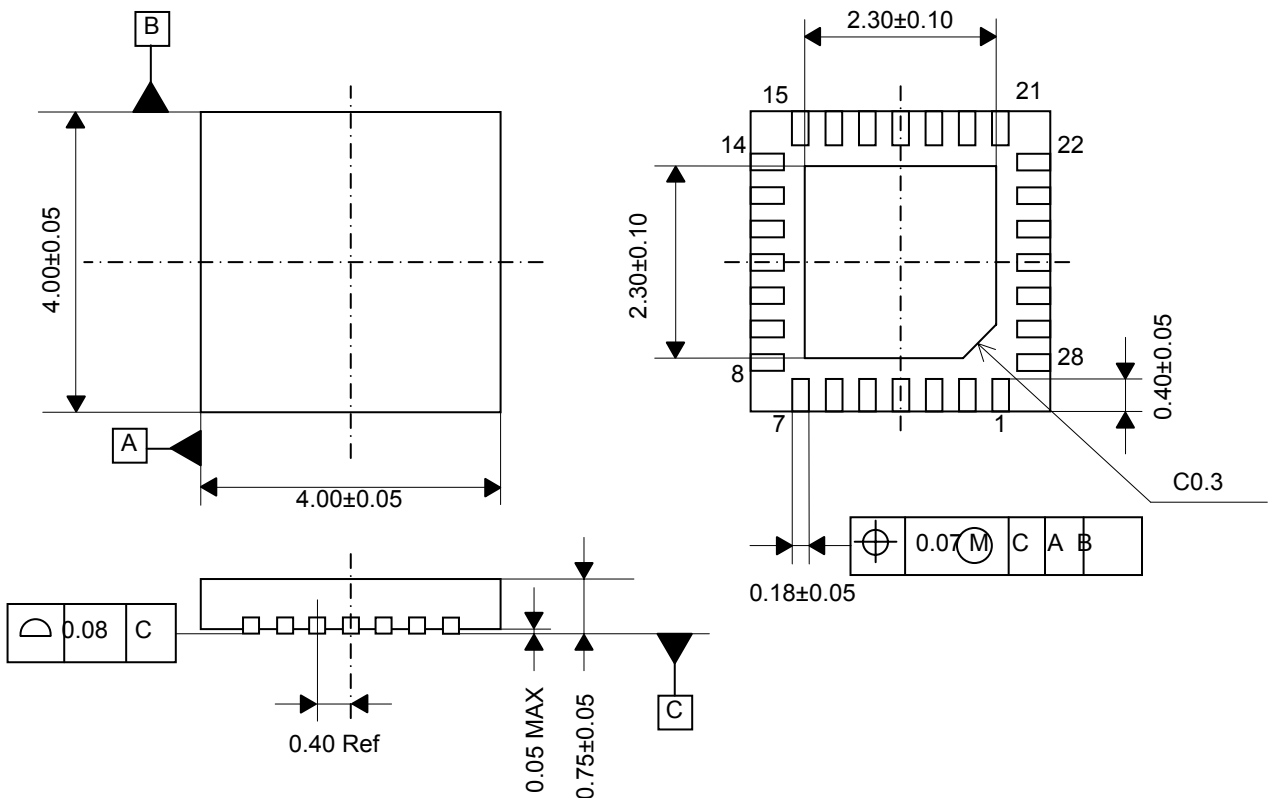
Y: Last digit of calendar year. (Year 2011->1, 2012->2)

WW: Manufacturing week number.

L: Lot identification, given to each product lot which is made in a week.
 LOT ID is given in alphabetical order (A, B, C...).

Mechanical Outline

Package : 28pin QFN (4.0 x 4.0 x 0.7mm, 0.4mm pitch)



Note) The exposure pad(Exposed Pad) of the center of the package back is connected to opening or VSS.

17. Important Notice

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